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SDAS153E – DECEMBER 1982 – REVISED AUGUST 1995

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

#### description

These octal buffers/drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable ( $\overline{OE}$ ) inputs, and complementary OE and  $\overline{OE}$  inputs. These devices feature high fan-out and improved fan-in.

The -1 version of SN74ALS241C is identical to the standard version, except that the recommended maximum  $I_{OL}$  of the -1 version is 48 mA. There is no -1 version of the SN54ALS241C.

The SN54ALS241C and SN54AS241A are characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74ALS241C and SN74AS241A are characterized for operation from 0°C to 70°C.

SN74ALS241C, SN74AS241A DW OR N PACKAGE	
(TOP VIEW)	

	(	,	
1OE [	1	20	] V <sub>CC</sub>
1A1 [	2	19	] 2OE
2Y4 [	3	18	] 1Y1
1A2 [	4	17	] 2A4
2Y3 [	5	16	] 1Y2
1A3 [	6		] 2A3
2Y2 [	7	14	] 1Y3
1A4 [	8	13	] 2A2
2Y1 [	9	12	] 1Y4
GND [	10	11	]2A1

# SN54ALS241C, SN54AS241A ... FK PACKAGE (TOP VIEW)



FUNCTION TABLES								
INP	UTS	OUTPUT						
10E	1A	1Y						
L	Н	Н						
L	L	L						
Н	Х	Z						
Н	Х	Z						

INPU	JTS	OUTPUT
20E	2A	2Y
Н	Н	Н
н	L	L
L	Х	Z

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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DALLAS, TEXAS 75265
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### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)

17

2A4



3 2Y4

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>‡</sup>

Supply voltage, V <sub>CC</sub>	
Input voltage, V <sub>I</sub>	
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T <sub>A</sub> : SN54ALS241C	55°C to 125°C
SN74ALS241C	0°C to 70°C
Storage temperature range	65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



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### recommended operating conditions

		SN54ALS241C		SN7				
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
IOH	High-level output current			-12			-15	mA
	Level and a development			12			24	
IOL	Low-level output current						48†	mA
Т <sub>А</sub>	Operating free-air temperature	-55		125	0		70	°C

<sup>†</sup> Applies only to the -1 version and only if V<sub>CC</sub> is between 4.75 V and 5.25 V

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN	54ALS24	1 <b>C</b>	SN7	4ALS24	1 <b>C</b>	
PARAMETER	TEST	TEST CONDITIONS -		TYP <sup>‡</sup>	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = 4.5 V,	lj = – 18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 \text{ V to 5.5 V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2	2		
		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH	V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -12 mA	2						V
		I <sub>OH</sub> = -15 mA				2			
		I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	
VOL	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 24 mA					0.35	0.5	V
		IOL = 48 mA (-1 version)					0.35	0.5	
IOZH	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.7 V			20			20	μΑ
IOZL	V <sub>CC</sub> = 5.5 V,	$V_{O} = 0.4 V$			-20			-20	μΑ
Ц	V <sub>CC</sub> = 5.5 V,	VI = 7 V			0.1			0.1	mA
IН	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
١ <sub>IL</sub>	V <sub>CC</sub> = 5.5 V,	$V_{  } = 0.4 V$			-0.1			-0.1	mA
١ <sub>0</sub> §	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
		Outputs high		9	17		9	18	
ICC	V <sub>CC</sub> = 5.5 V	Outputs low		15	28		15	26	mA
		Outputs disabled		17	32		17	30	

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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#### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$					UNIT
			SN54AL	S241C	SN74AL	S241C	
			MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	•	N N	3	31	2	11	
<sup>t</sup> PHL	A	Y	1	17	3	10	ns
<sup>t</sup> PZH	1 <del>0E</del>	N N	3	33	3	21	
<sup>t</sup> PZL	10E	Y	3	27	4	21	ns
<sup>t</sup> PHZ	405	N N	2	17	1	10	
<sup>t</sup> PLZ	1 <del>0E</del>	Y	2	32	2	15	ns
<sup>t</sup> PZH	205	N N	3	38	4	21	
tpzL	20E	Y	3	30	5	21	ns
<sup>t</sup> PHZ	20E	Y	2	17	2	10	
<sup>t</sup> PLZ	20E	Ϋ́	3	35	3	15	ns

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>‡</sup>

Supply voltage, V <sub>CC</sub>	
Input voltage, V <sub>I</sub>	
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T <sub>A</sub> : SN54AS241A	55°C to 125°C
SN74AS241A	0°C to 70°C
Storage temperature range	65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		SN54AS241A		1A	SN	LINUT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
$V_{ L}$	Low-level input voltage			0.8			0.8	V
IOH	High-level output current			-12			-15	mA
IOL	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C



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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN	SN54AS241A MIN TYP <sup>†</sup> MAX		SN	SN74AS241A MIN TYP <sup>†</sup> MAX		
PARAMETER	TEST C	ONDITIONS	MIN			MIN			UNIT
VIK	V <sub>CC</sub> = 4.5 V,	lj = – 18 mA			-1.2			-1.2	V
	V <sub>CC</sub> = 4.5 V to 5.5 V,	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2	2		
		$I_{OH} = -3 \text{ mA}$	2.4	3.4		2.4	3.4		
VOH	V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = – 12 mA	2.4						V
		I <sub>OH</sub> = – 15 mA				2.4			
	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA		0.27	0.55				
V <sub>OL</sub>		I <sub>OL</sub> = 64 mA					0.31	0.55	V
IOZH	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.7 V			50			50	μΑ
IOZL	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.4 V			-50			-50	μΑ
lj	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 7 V			0.1			0.1	mA
Ιн	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μA
١ <sub>IL</sub>	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-1			-1	mA
IO‡	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-50		-150	-50		-150	mA
		Outputs high		22	35		22	35	
ICC	V <sub>CC</sub> = 5.5 V	Outputs low		61	90		61	90	mA
		Outputs disabled		35	56		35	56	

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. <sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>.

### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)					5 V, §	UNIT
			SN54A	S241A	SN74A	S241A	
			MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	•	N N	2	9	2	6.2	
<sup>t</sup> PHL	A	Y	1	7	1	6.2	ns
<sup>t</sup> PZH	405	N N	1	10	1	9	
<sup>t</sup> PZL	10E	Y	2	8	2	7.5	ns
<sup>t</sup> PHZ	1 <mark>0E</mark>	N N	1	6.5	1	6	
<sup>t</sup> PLZ	IOE	Y	1	10.5	1	9	ns
<sup>t</sup> PZH	205	N N	2	11	2	10.5	
<sup>t</sup> PZL	20E	Y	3	9.5	3	8.5	ns
<sup>t</sup> PHZ	20E	Y	1	7	1	7	
<sup>t</sup> PLZ	20E	Ť	2	12	2	12	ns

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz, t<sub>r</sub> = t<sub>f</sub> = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

#### Figure 1. Load Circuits and Voltage Waveforms





### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/38302BRA	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type		JM38510/ 38302BRA	Samples
M38510/38302BRA	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 38302BRA	Samples
SN54ALS241CJ	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS241CJ	Samples
SN54AS241AJ	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54AS241AJ	Samples
SN74ALS241CDW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	0 to 70	ALS241C	
SN74ALS241CDWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS241C	Samples
SN74ALS241CN	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS241CN	Samples
SN74AS241AN	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS241AN	Samples
SNJ54ALS241CFK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54 ALS241CFK	Samples
SNJ54ALS241CJ	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54ALS241CJ	Samples
SNJ54AS241AJ	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54AS241AJ	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.



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# PACKAGE OPTION ADDENDUM

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ALS241C, SN54AS241A, SN74ALS241C, SN74AS241A :

- Catalog : SN74ALS241C, SN74AS241A
- Military : SN54ALS241C, SN54AS241A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



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### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS241CDWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1



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# PACKAGE MATERIALS INFORMATION

16-Apr-2024



\*All dimensions are nominal

Device Package Type		Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS241CDWR	SOIC	DW	20	2000	367.0	367.0	45.0

### TEXAS INSTRUMENTS

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## TUBE



# - B - Alignment groove width

#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SN74ALS241CN	N	PDIP	20	20	506	13.97	11230	4.32
SN74AS241AN	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54ALS241CFK	FK	LCCC	20	55	506.98	12.06	2030	NA

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# FK 20

## 8.89 x 8.89, 1.27 mm pitch

# **GENERIC PACKAGE VIEW**

# LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



# **DW0020A**



# **PACKAGE OUTLINE**

# SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



# DW0020A

# **EXAMPLE BOARD LAYOUT**

# SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DW0020A

# **EXAMPLE STENCIL DESIGN**

# SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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